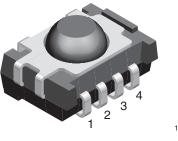
TSSP6038



Vishay Semiconductors

IR Receiver Modules for Remote Control Systems



16797

MECHANICAL DATA

Pinning

 $1 = GND, 2 = N.C., 3 = V_S, 4 = OUT$

ORDERING CODE

Taping:

TSSP6038TT - top view taped TSSP6038TR - side view taped

APPLICATIONS

- Reflective sensors for hand dryers, towel or soap dispensers, water faucets, toilet flush
- Vending machine fall detection
- · Security and pet gates
- Person or object vicinity activation

FEATURES

- Up to 2 m for presence sensing
- Uses modulated bursts at 38 kHz
- 940 nm peak wavelength
- PIN diode and sensor IC in one package
- Low supply current
- Shielding against EMI
- Visible light is suppressed by IR filter
- Insensitive to supply voltage ripple and noise
- Supply voltage: 2.5 V to 5.5 V
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

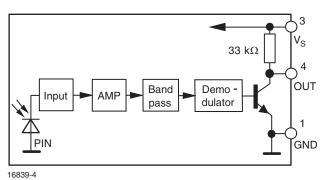
DESCRIPTION

The TSSP57038 is a compact infrared detector module for presence sensing applications. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

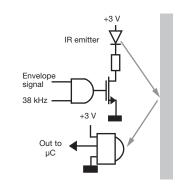
This component has not been qualified according to automotive specifications.

PARTS TABLE	
Carrier frequency 38 kHz	TSSP6038
Package	Panhead
Pinning	1 = GND, 2 = N.C., 3 = V _S , 4 = OUT
Dimensions (mm)	7.5 W x 5.3 H x 4.0 D
Mounting	SMD
Application	Presence sensors

BLOCK DIAGRAM



PRESENCE SENSING





RoHS COMPLIANT HALOGEN FREE GREEN (5-2008)

Rev. 1.3, 31-Aug-15

1

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ABSOLUTE MAXIMUM I	ITE MAXIMUM RATINGS			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		VS	-0.3 to +6	V
Supply current		I _S	5	mA
Output voltage		Vo	-0.3 to (V _S + 0.3)	V
Output current		Ι _Ο	5	mA
Junction temperature		Тj	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW
Soldering temperature	$t \le 10$ s, 1 mm from case	T _{sd}	260	°C

Note

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

ELECTRICAL AND OPTI	LECTRICAL AND OPTICAL CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply ourrest (sin 2)	$E_v = 0, V_S = 5 V$	I _{SD}	0.55	0.7	0.9	mA
Supply current (pin 3)	$E_v = 40$ klx, sunlight	I _{SH}	-	0.8	-	mA
Supply voltage		Vs	2.5	-	5.5	V
Transmission distance	$E_v = 0$, test signal see fig. 1, IR diode TSAL6200, I _F = 400 mA	d	-	25	-	m
Output voltage low (pin 1)	l _{OSL} = 0.5 mA, E _e = 2 mW/m², test signal see fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see fig. 1	E _{e min.}	-	0.7	1.2	mW/m ²
Maximum irradiance	$\begin{array}{c} t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o, \\ test \ signal \ see \ fig. \ 1 \end{array}$	E _{e max.}	50	-	-	W/m ²
Directivity	Angle of half transmission distance	φ1/2	-	± 50	-	deg



TYPICAL CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)

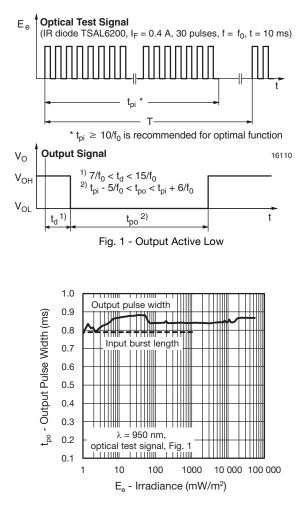
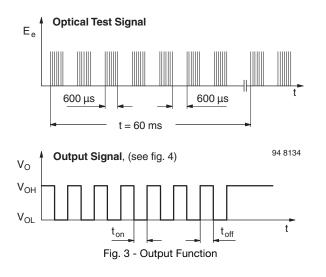


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient



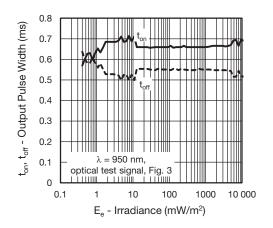


Fig. 4 - Output Pulse Diagram

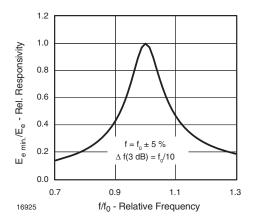


Fig. 5 - Frequency Dependence of Responsivity

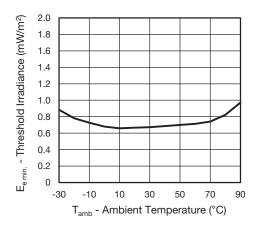


Fig. 6 - Sensitivity vs. Ambient Temperature

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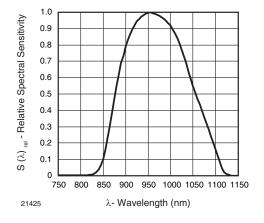


Fig. 7 - Relative Spectral Sensitivity vs. Wavelength

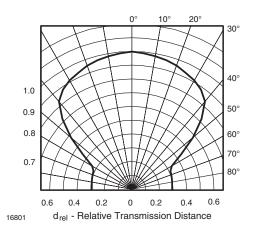


Fig. 8 - Horizontal Directivity

The typical application of this device is a reflective or beam break sensor with active low "detect" or "no detect" information contained in its output. Applications requiring up to 2 m beam break or 1 m reflective range benefit from the lower gain of these sensors because they are less sensitive to stray signal from the emitter, simplifying the mechanical design.

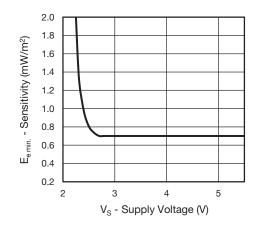
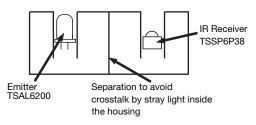


Fig. 9 - Sensitivity vs. Supply Voltage



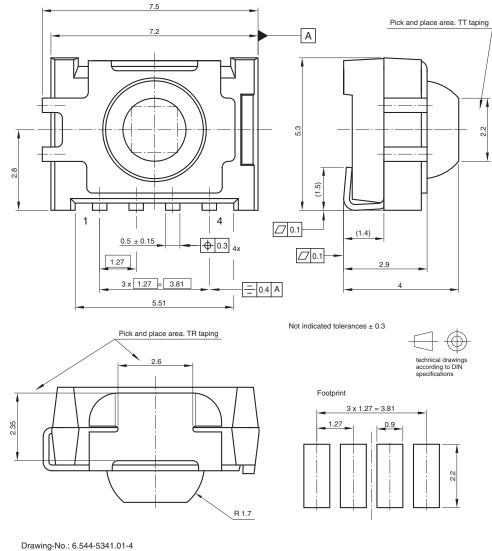


There should be no common window in front of the emitter and detector in order to avoid crosstalk via guided light through the window.





PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.544-5341.01-4 Issue: 8; 02.09.09

ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

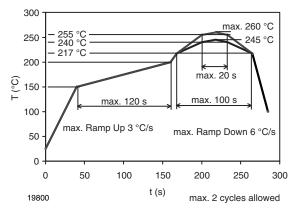
Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- · Handle products only after the temperature has cooled off

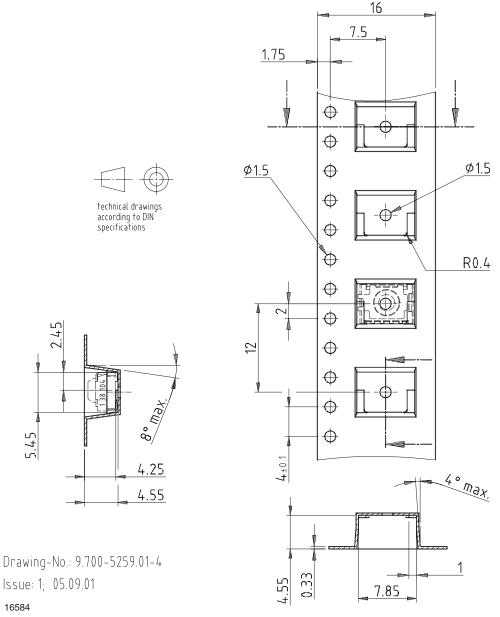




VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSSP6038TT DIMENSIONS in millimeters



Rev. 1.3, 31-Aug-15

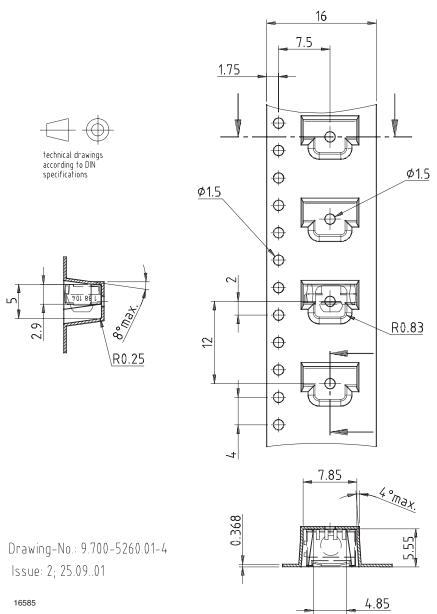
6

Document Number: 82483

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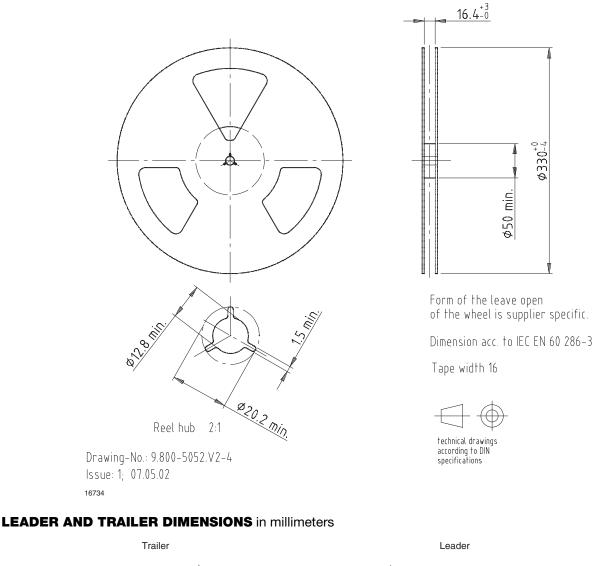
TAPING VERSION TSSP6038TR DIMENSIONS in millimeters

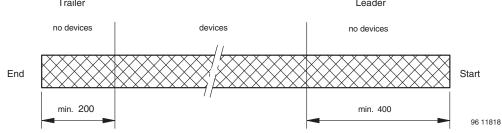






REEL DIMENSIONS in millimeters





COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. ± 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

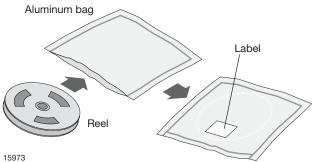
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.



VISHAY SEMICONDUCTOR Gr	nbH STANDARD BAR CODE PRO	DUCT LABEL (finished goods)
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	XXXXXXX+	Company logo
LONG BAR CODE TOP	ТҮРЕ	LENGTH
Item-number	Ν	8
Plant-code	N	2
Sequence-number	Х	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	ТҮРЕ	LENGTH
Selection-code	Х	3
Data-code	Ν	3
Batch-number	Х	10
Filter	-	1
Total length	-	17

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

Rev. 1.3, 31-Aug-15

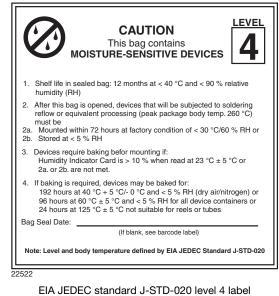
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 $^{\circ}\text{C}$ + 5 $^{\circ}\text{C}$ / - 0 $^{\circ}\text{C}$ and < 5 % RH (dry air / nitrogen) or

96 h at 60 $^{\circ}\text{C}$ + 5 $^{\circ}\text{C}$ and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard J-STD-020 level 4 label is included on all dry bags.



IA JEDEC standard J-STD-020 level 4 label is included on all dry bags

Document Number: 82483

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ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD **BAR CODE LABELS**

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.





Tape and Reel Standards for SMD IR Receiver Modules

Vishay Semiconductor SMD IR Receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Туре
- Group
- Tape code, normally part of type name
- Production code
- Quantity

MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

NUMBER OF COMPONENTS

- A. Panhead SMD: quantity per reel: TT, SMD top view package, 1190 pcs
 - TR, SMD side view package, 1120 pcs
- B. Heimdall: quantity per reel:
 TT, Heimdall top view package, 2200 pcs
 TR, Heimdall side view package, 2300 pcs
- C. Heimdall without lens: quantity per reel: WTT, top view package, 2200 pcs WTR, side view package, 2300 pcs
- D. Bugeye: quantity per reel:
 - TT, 2500 pcs TR, 2500 pcs
- E. AP5: quantity per reel:
 - TT, 2500 pcs
 - TR, not available in side view
- F. Belobog: quantity per reel:
 - TT1, 1800 pcs
 - TT2, 7000 pcs
 - TR, not available in side view
- G. Belobog with shield: quantity per reel:
 - TT1, 1500 pcs
 - TT2, 5000 pcs

ORDER DESIGNATION

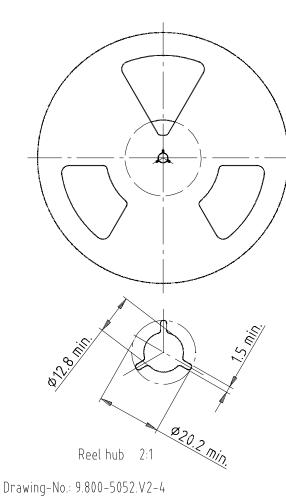
The type designation of the device is extended by TT or TT1 for top view or TR for side view.

Example:

- TSOP6238TR (reel packing) TSOP75238TR (reel packing) TSOP75338WTT (reel packing) TSOP85438TT (reel packing)
- TSOP85238AP5TR (reel packing)
- TSOP57438TT1 (reel packing)
- TSOP57238HTT1 (reel packing)



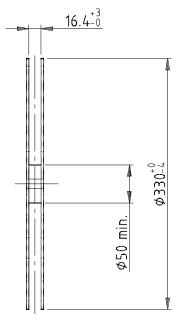
REEL DIMENSIONS FOR PANHEAD SMD AND HEIMDALL in millimeters



Drawing-No.: 9.800-5052.V Issue: 1; 07.05.02 16734

Note

• The body structure of the reel can vary



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16



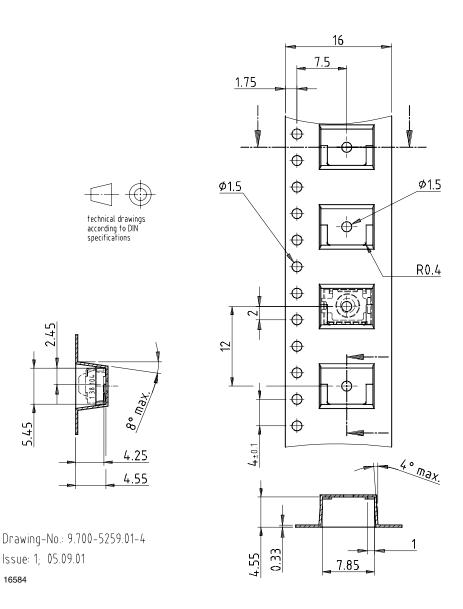
technical drawings according to DIN specifications

Rev. 2.1, 13-Oct-15



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

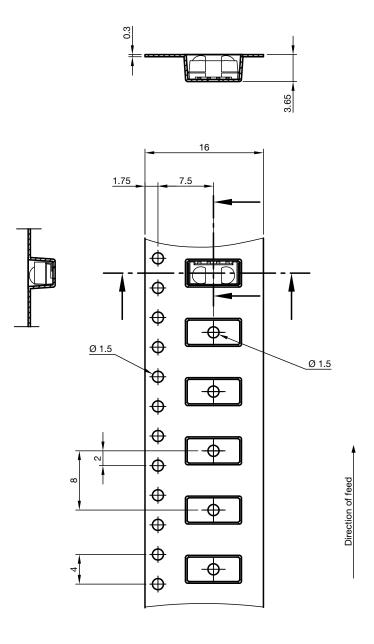
A. Panhead SMD (TSOP36...TT, TSOP35...TT, TSOP6...TT)





TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall SMD (TSOP75...TT, TSOP77...TT)





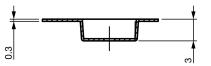
technical drawings according to DIN specifications

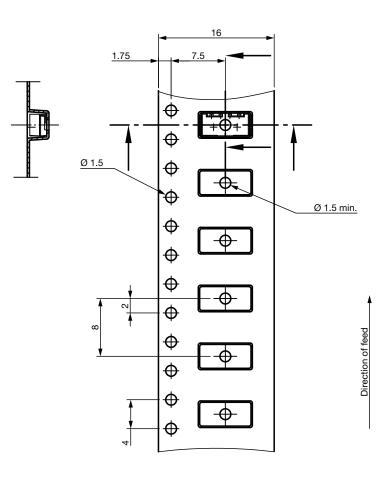
Drawing-No.: 9.700-5338.01-4 Issue: 4; 12.06.13



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall SMD without lens (TSOP75...WTT, TSOP77...WTT)







technical drawings according to DIN specifications

Drawing-No.: 9.700-5341.01-4 Issue: 3; 06.10.15

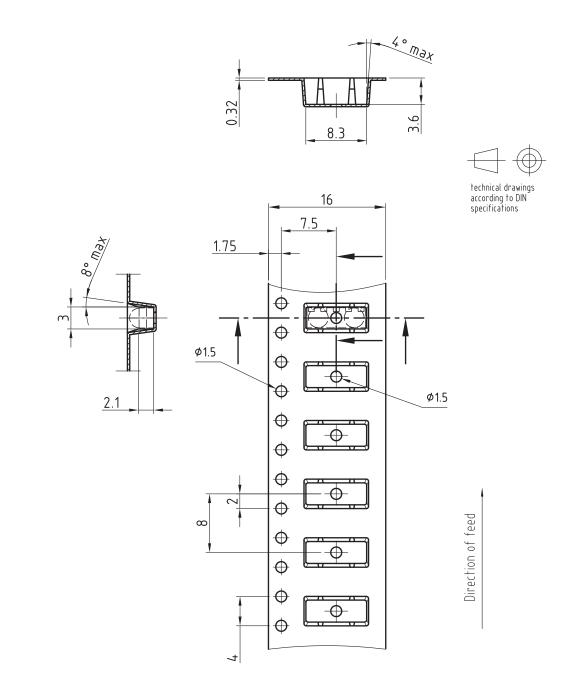


TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

D. Bugeye (TSOP85...TT)

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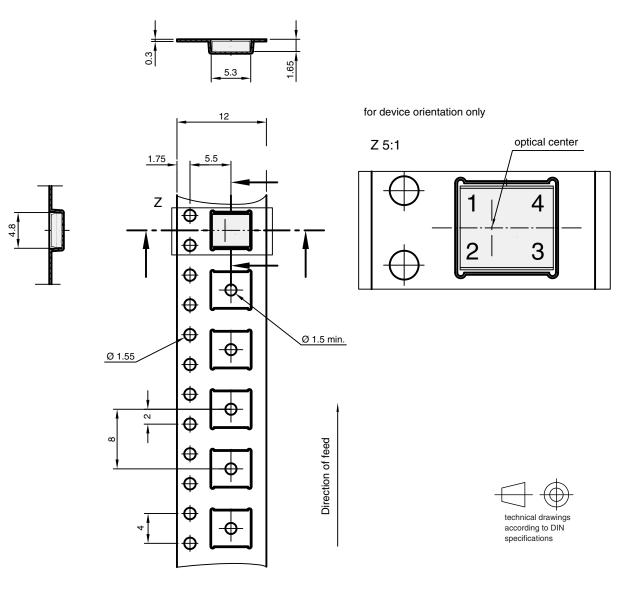
Drawing-No.: 9.700-5317.01-4 Issue: 2; 10.04.08 20629

Rev. 2.1, 13-Oct-15



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

E. AP5 (TSOP85...AP5TT)

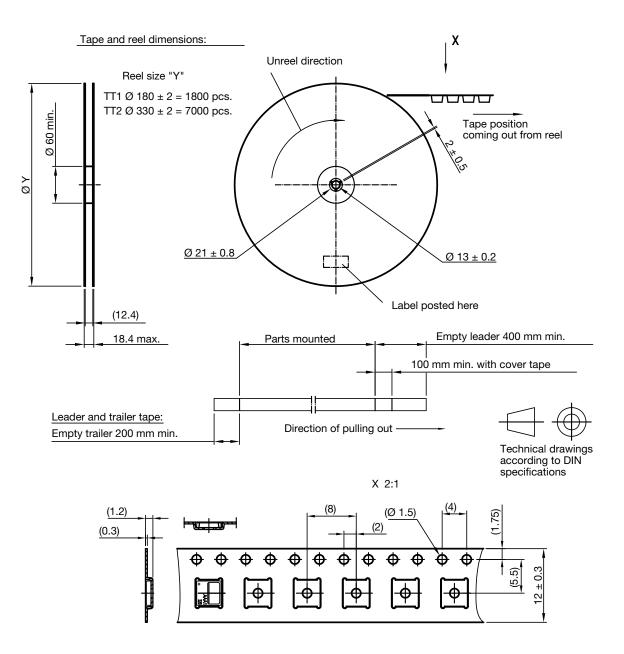


Drawing-No.: 9.700-5346.01-4 Issue: 2, 24.11.09 ²¹⁹⁴⁵



TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

F. Belobog (TSOP37...TT1, TSOP37...TT2, TSOP57...TT1, TSOP57...TT2)



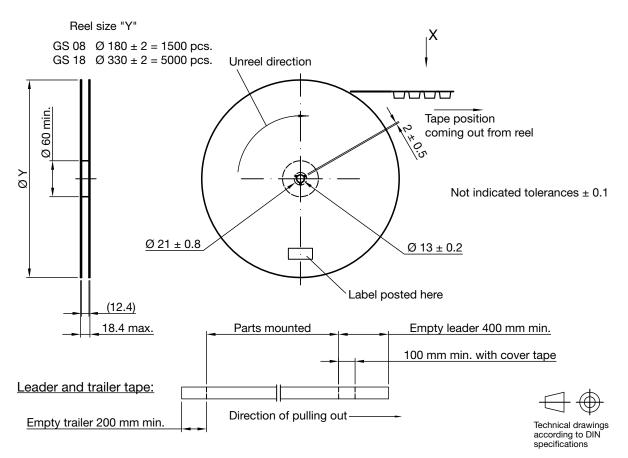
Drawing-No.: 9.700-5347.01-4 Issue: 1; 14.11.11 Not indicated tolerances ± 0.1



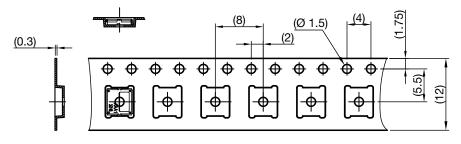
TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

G. Belobog with shield (TSOP37...HTT1, TSOP37...HTT2, TSOP57...HTT1, TSOP57...HTT2)

Tape and Reel dimensions:



X 2:1



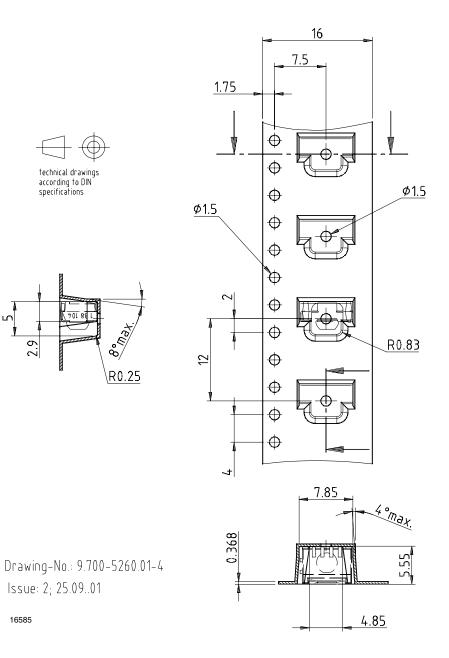
Reel dimensions and tape

Drawing-No.: 9.700-5380.01-4 Issue: 1; 28.10.13



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

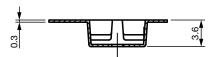
A. Panhead SMD (TSOP36...TR, TSOP35...TR, TSOP6...TR)

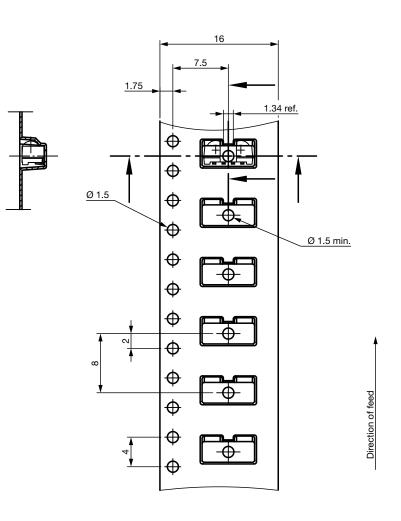




TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall SMD (TSOP75..., TSOP77...)







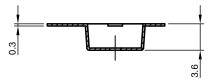
technical drawings according to DIN specifications

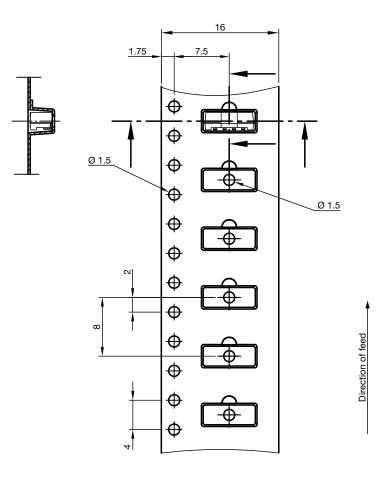
Drawing-No.: 9.700-5337.01-4 Issue: 2; 06.10.15



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

C. Heimdall SMD without lens (TSOP75...WTR, TSOP77...WTR)







technical drawings according to DIN specifications

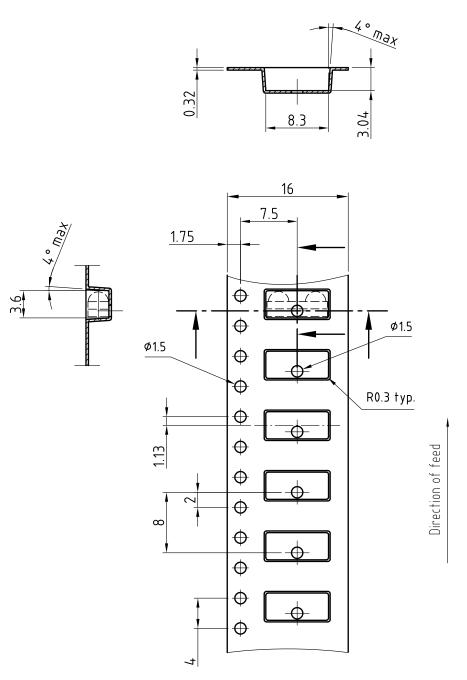
Drawing-No.: 9.700-5342.01-4 Issue: 2; 12.06.13

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

D. Bugeye (TSOP85...TR)

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technical drawings

according to DIN specifications

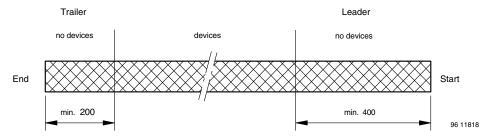
Drawing-No.: 9.700-5316.01-4 Issue: 1; 12.02.07 20628

Rev. 2.1, 13-Oct-15





LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE REEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. \pm 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

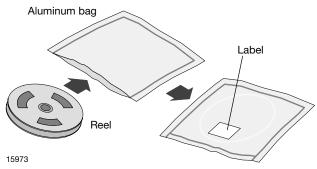
PLAIN WRITING	ABBREVIATION	LENGTH	
Item-description	-	18	
Item-number	INO	8	
Selection-code	SEL	3	
LOT-/serial-number	BATCH	10	
Data-code	COD	3 (YWW)	
Plant-code	PTC	2	
Quantity	QTY	8	
Accepted by	ACC	-	
Packed by	PCK	-	
Mixed code indicator	MIXED CODE	-	
Origin	XXXXXXX+	Company logo	
LONG BAR CODE TOP	ТҮРЕ	LENGTH	
Item-number	Ν	8	
Plant-code	Ν	2	
Sequence-number	Х	3	
Quantity	Ν	8	
Total length	-	21	
SHORT BAR CODE TOP	ТҮРЕ	LENGTH	
Selection-code	Х	3	
Data-code	Ν	3	
Batch-number	Х	10	
Filter	-	1	
Total length	-	17	

Rev. 2.1, 13-Oct-15



DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 $^{\circ}\text{C}$ + 5 $^{\circ}\text{C}$ / - 0 $^{\circ}\text{C}$ and < 5 % RH (dry air/nitrogen) or

96 h at 60 $^\circ\text{C}$ + 5 $^\circ\text{C}$ and < 5 % RH for all device containers or

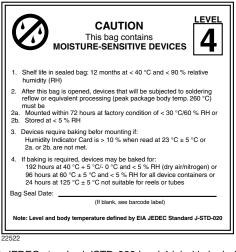
24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard JSTD-020 level 4 label is included on all dry bags.

OUTER PACKAGING

The sealed reel is packed into a pizza box.

Vishay Semiconductors



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

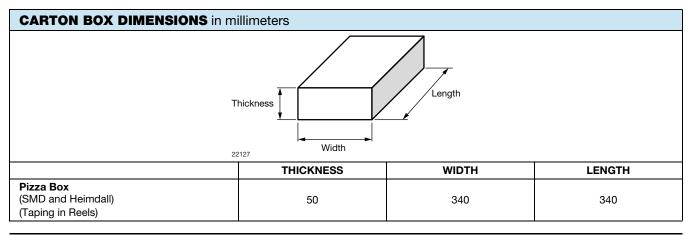
ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.





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